

MOS FIELD EFFECT TRANSISTOR 2SK3638

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK3638 is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, and designed for low voltage high current applications such as DC/DC converter with synchronous rectifier.

ORDERING INFORMATION

PART NUMBER	PACKAGE		
2SK3638-ZK	TO-252 (MP-3ZK)		

FEATURES

• Low on-state resistance

 $R_{\text{DS(on)1}} = 8.5~\text{m}\Omega$ MAX. (VGs = 10 V, ID = 32 A)

 $R_{DS(on)2} = 15 \text{ m}\Omega$ MAX. (Vgs = 4.5 V, ID = 18 A)

- Low Ciss: Ciss = 1100 pF TYP.
- Built-in gate protection diode

(TO-252)



ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

	Drain to Source Voltage (Vgs = 0 V)	VDSS	20	V
	Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V
*	Drain Current (DC) (Tc = 25°C)	I _{D(DC)}	±64	Α
	Drain Current (pulse) Note	D(pulse)	±220	Α
	Total Power Dissipation (Tc = 25°C)	P _{T1}	36	W
	Total Power Dissipation	P _{T2}	1.0	W
	Channel Temperature	Tch	150	°C
	Storage Temperature	Tstg	-55 to +150	°C

Note PW \leq 10 μ s, Duty Cycle \leq 1%

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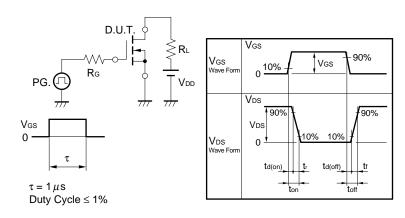


★ ELECTRICAL CHARACTERISTICS (TA = 25°C)

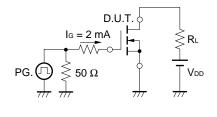
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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	V _{DS} = 20 V, V _{GS} = 0 V			10	μΑ
Gate Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5		2.5	V
Forward Transfer Admittance Note	y _{fs}	V _{DS} = 10 V, I _D = 32 A	12	25		S
Drain to Source On-state Resistance Note	R _{DS(on)1}	Vgs = 10 V, ID = 32 A		6.8	8.5	mΩ
	R _{DS(on)2}	Vgs = 4.5 V, ID = 18 A		10	15	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		1100		pF
Output Capacitance	Coss	Vgs = 0 V		450		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		170		pF
Turn-on Delay Time	td(on)	V _{DD} = 10 V, I _D = 32 A		10		ns
Rise Time	tr	Vgs = 10 V		4.3		ns
Turn-off Delay Time	td(off)	$R_G = 10 \Omega$		35		ns
Fall Time	tf			9.7		ns
Total Gate Charge	Q _G	V _{DD} = 16 V		22		nC
Gate to Source Charge	Q _G s	Vgs = 10 V		4.3		nC
Gate to Drain Charge	Q _{GD}	ID = 64 A		5.1		nC
Body Diode Forward Voltage Note	V _F (S-D)	IF = 64 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 64 A, VGS = 0 V		31		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		23		nC

Note Pulsed: PW \leq 350 μ s, Duty Cycle \leq 2%

TEST CIRCUIT 1 SWITCHING TIME

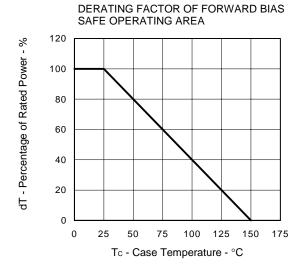


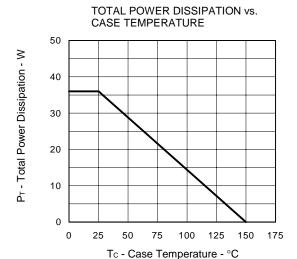
TEST CIRCUIT 2 GATE CHARGE



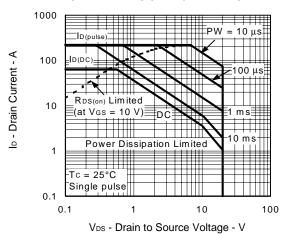


TYPICAL CHARACTERISTICS (TA = 25°C)

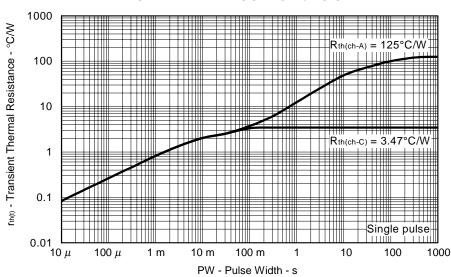




FORWARD BIAS SAFE OPERATING AREA

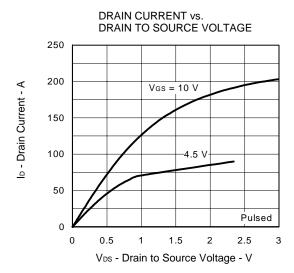


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

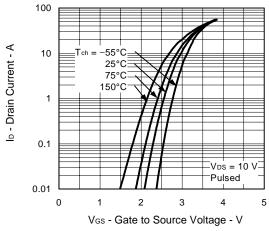


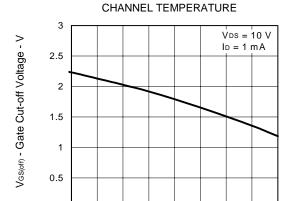
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★ FORWARD TRANSFER CHARACTERISTICS



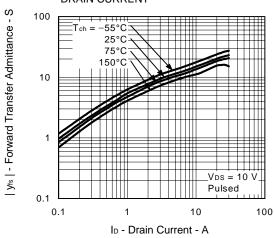


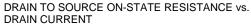
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-50

GATE CUT-OFF VOLTAGE vs.

★ FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

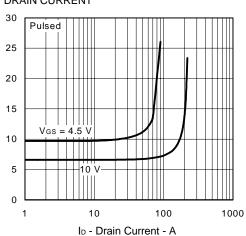




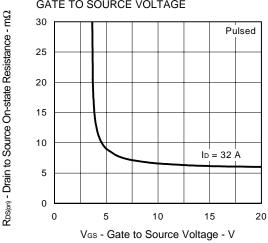
Tch - Channel Temperature - °C

100

150



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

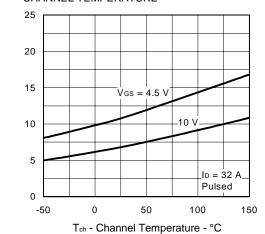


R_{DS(o1)} - Drain to Source On-state Resistance - mΩ

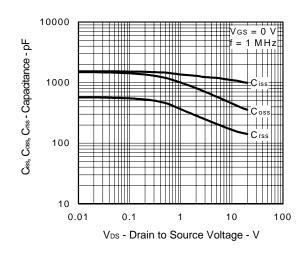


RDS(m) - Drain to Source On-state Resistance - m\Omega

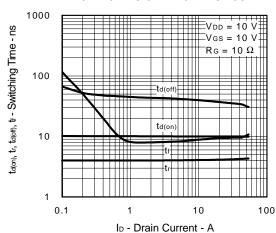
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



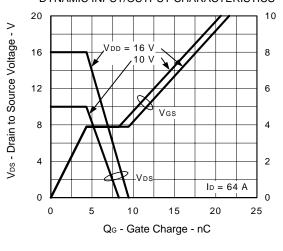
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



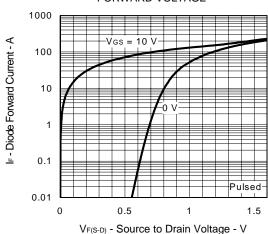
SWITCHING CHARACTERISTICS



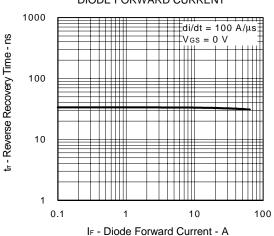
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



★ SOURCE TO DRAIN DIODE FORWARD VOLTAGE



REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT

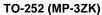


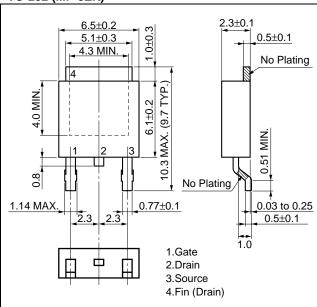
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Ves - Gate to Source Voltage - V



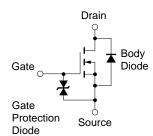
PACKAGE DRAWING (Unit: mm)





the rated voltage may be applied to this device.

EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding

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